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QUADRUPLE 2-INPUT AND GATES

Description

The 74LVC08A provides four independent 2-input AND gates. The device is designed for operation with a power supply range of 1.65V to 5.5V. The inputs are tolerant to 5.5V allowing this device to be used in a mixed voltage environment. The device is fully specified for partial power down applications using IOFF. The IOFF circuitry disables the output preventing damaging current backflow when the device is powered down.

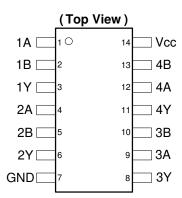
The gates perform the positive Boolean function:

$$Y = A \bullet B$$
 or $Y = \overline{\overline{A} + \overline{B}}$

Features

- Wide Supply Voltage Range from 1.65V to 5.5V
- Sinks 24mA at V_{CC} = 3.3V
- CMOS low power consumption
- IOFF Supports Partial-Power-Down Mode Operation
- Inputs or outputs accept up to 5.5V
- Inputs can be driven by 3.3V or 5.5V allowing for voltage translation applications.
- ESD Protection Exceeds JESD 22
 - 200-V Machine Model (A115-A)
 - 2000-V Human Body Model (A114-A)
 - Exceeds 1000-V Charged Device Model (C101C)
- Latch-Up Exceeds 250 mA per JESD 78, Class II
- · Range of Package Options SO-14 and TSSOP-14
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Pin Assignments



SO-14 / TSSOP-14

Applications

- Voltage Level Shifting
- General Purpose Logic
- Power Down Signal Isolation
- · Wide array of products such as:
 - PCs, networking, notebooks, ultrabooks, netbooks
 - Computer peripherals, hard drives, CD/DVD ROM
 - TV, DVD, DVR, set top box

Notes:

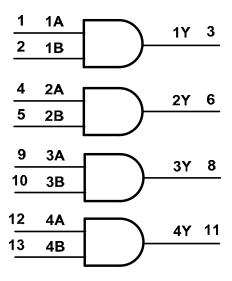
- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



Pin Descriptions

Pin Number	Pin Name	Description
1	1A	Data Input
2	1B	Data Input
3	1Y	Data Output
4	2A	Data Input
5	2B	Data Input
6	2Y	Data Output
7	GND	Ground
8	3Y	Data Output
9	3A	Data Input
10	3B	Data Input
11	4Y	Data Output
12	4A	Data Input
13	4B	Data Input
14	V _{CC}	Supply Voltage

Logic Diagram



Function Table

Inp	Output		
Α	A B		
L	L	L	
L	Н	L	
Н	L	L	
Н	Н	Н	



Absolute Maximum Ratings (Note 4) (@T_A = +25°C, unless otherwise specified.)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD CDM	Charged Device Model ESD Protection	1	KV
ESD MM	Machine Model ESD Protection	200	V
V _{CC}	Supply Voltage Range	-0.5 to 6.5	V
Vı	Input Voltage Range	-0.5 to 6.5	V
Vo	Voltage applied to output in high impedance or I _{OFF} state	-0.5 to 6.5	V
Vo	Voltage applied to output in high or low state	-0.3 to V _{CC} +0.5	V
lık	Input Clamp Current V _I < 0	-50	mA
I _{OK}	Output Clamp Current V _O < 0	-50	mA
Io	Continuous output current	±50	mA
I _{CC} ,, I _{GND}	Continuous current through V _{CC} or GND	±100	mA
TJ	T _J Operating Junction Temperature		°C
T _{STG}	Storage Temperature	-65 to +150	°C
P _{TOT}	Total Power Dissipation	500	mW

Note: 4. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.

Recommended Operating Conditions (Note 5) (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	Supply Voltage		1.65	5.5	V
VI	Input Voltage		0	5.5	V
V	N	Active Mode	0	V _{CC}	V
Vo	Output Voltage	V _{CC} = 0V; Power Down Mode	0	5.5	V
A./A.\/		V _{CC} = 1.65V to 2.7V		20	0.4
Δt/ΔV	Input transition rise or fall rate	V _{CC} = 2.7V to 5.5V		10	ns/V
T _A	Operating free-air temperature		-40	+125	°C

Notes: 5. Unused inputs should be held at $V_{\mbox{CC}}$ or Ground.



Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Symbol Parameter		Tank Oam dikinga	.,,	$T_A = -40$ °C		to +85°C $T_A = -40$ °C to +125°C		Unit	
		Test Conditions	V _{cc}	Min	Max	Min	Max	Unit	
			1.65V to 1.95V	0.65 X V _{CC}		0.65 X V _{CC}			
V_{IH}	High-level		2.3V to 2.7V	1.7		1.6		V	
	Input Voltage		2.7V to 3.6V	2.0		2.0			
			1.65V to 1.95V		0.35 X V _{CC}		0.35 X V _{CC}		
V_{IL}	Low-level input voltage		2.3V to 2.7V		0.7		0.7	V	
	input voitage		2.7V to 3.6V		0.8		0.8		
		$I_{OH} = -100\mu A$	1.65V to 3.6V	V _{CC} - 0.2		V _{CC} - 0.3			
		$I_{OH} = -4mA$	1.65V	1.2					
1/	High Level	$I_{OH} = -8mA$	2.3V	1.9					
VOH	V _{OH} Output Voltage	I 10 A	2.7V	2.2		2.05		V	
	Voltage	I _{OH} = -12mA	3.0V	2.3		2.1			
		$I_{OH} = -24mA$	3.0V	2.2		2.0			
		$I_{OH} = 100 \mu A$	1.65V to 3.6V 0.2			0.3			
		$I_{OH} = 4mA$	1.65V		0.45		0.6]	
V	High-level	$I_{OH} = 8mA$	2.3V		0.70		0.85		
V_{OL}	Output Voltage	I 10m A	2.7V		0.40		0.6	V	
	Voltage	I _{OH} = 12mA	3.0V		0.55		0.6		
		I _{OH} =-24mA	3.0V		0.55		0.6		
II	Input Current	$V_I = GND \text{ to } 5.5V$	3.6V		± 5		± 20	μΑ	
l _{OFF}	Power Down Leakage Current	V_1 or $V_0 = 0$ V to 3.6V	0		10		20	μΑ	
Icc	Supply Current	$V_I = GND \text{ or } V_{CC}$ $I_{C}=0$	3.6V		10		40	μA	
Δl _{CC}	Additional Supply Current	One input at V _{CC} – 0.6V Other at V _{CC} or Gnd.	2.7V to 3.6V		500		5000	μA	



Switching Characteristics

Combal Baramatar		Test	Test	T _A = +25°C		-40°C to +85°C		-40°C to +125°C		Unit	
Symbol	Symbol Parameter		V _{cc}	Min	Тур	Max	Min	Max	Min	Max	Unit
	Propagation		1.65V to1.95V	1.0	5.0	9.3	1.0	9.8	1.0	11.3	
		Figure 1	2.3V to 2.7V	1.0	2.9	6.4	1.0	6.9	1.0	9.0	
t _{PD}	Delay A _N or B _N to Y _N		2.7V	1.0	3.0	4.6	1.0	4.8	1.0	6.0	ns
	IO YN		3V to 3.6V	1.0	2.6	3.9	1.0	4.1	1.0	5.5	
t _{SK(0)}	Output Skew Time		3V to 3.6V					1.0		1.5	ns

Operating Characteristics (@T_A = +25°C, unless otherwise specified.)

	Parameter	Test Conditions	V _{CC} = 1.8V Typ	V _{CC} = 2.5V Typ	V _{CC} = 3.3V Typ	Unit
C _{pd}	Power dissipation capacitance per gate	f = 10 MHz	7.0	7.5	8.0	pF
Cı	Input Capacitance	$V_i = V_{CC} - or$ GND	4	4	4	pF

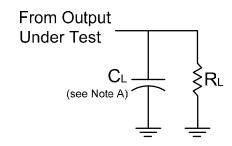
Package Characteristics

Symbol	Parameter	Test Conditions	V _{cc}	Min	Тур	Max	Unit	
Δ	Thermal Resistance	SO-14	(Note 6)		TBD		°C/W	
θ _{JA}	Junction-to-Ambient	TSSOP-14	(Note 6)		159		C/VV	
	Thermal Resistance	SO-14	(Nata C)		TBD		°C/W	
θЈС	Junction-to-Case	TSSOP-14	(Note 6)		25			

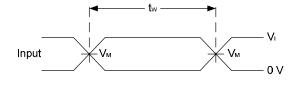
Note: 6. Test condition for SO-14 and TSSOP-14: Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



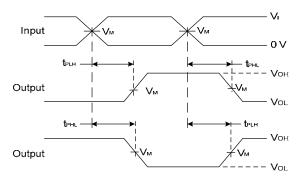
Parameter Measuement Information



V	Inputs		V	C.	D.
V _{CC}	VI	t _r /t _f	· V _M	CL	R∟
1.8V±0.15V	V _{CC}	≤2ns	V _{CC} /2	30pF	1ΚΩ
2.5V±0.2V	V _{CC}	≤2ns	V _{CC} /2	30pF	500Ω
2.7V	2.7V	≤2.5ns	1.5V	50pF	500Ω
3.3V±0.3V	2.7V	≤2.5ns	1.5V	50pF	500Ω



Voltage Waveform Pulse Duration



Voltage Waveform Propagation Delay Times Inverting and Non Inverting Outputs

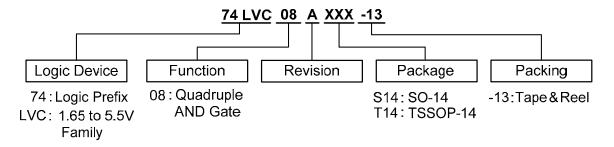
Notes: A. Includes test lead and test apparatus capacitance.

- B. All pulses are supplied at pulse repetition rate ≤ 10 MHz
- C. Inputs are measured separately one transition per measurement
- D. t_{PLH} and t_{PHL} are the same as t_{PD}

Figure 1. Load Circuit and Voltage Waveforms



Ordering Information

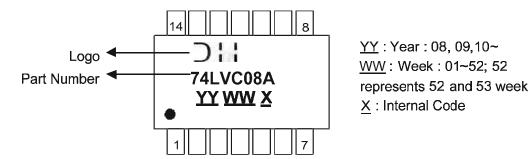


Device	Package	Packaging	13" Tape and Reel	
Device	Code	(Note 7)	Quantity	Part Number Suffix
74LVC08AS14-13	S14	SO-14	2500/Tape & Reel	-13
74LVC08AT14-13	T14	TSSOP-14	2500/Tape & Reel	-13

Notes: 7. The taping orientation and tape details can be found at http://www.diodes.com/datasheets/ap02007.pdf

Marking Information

(1) SO-14, TSSOP-14

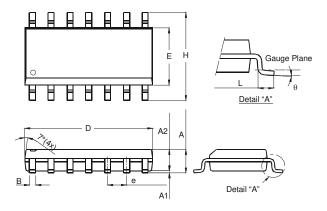


Part Number	Package
74LVC08AS14	SO-14
74LVC08AT14	TSSOP-14



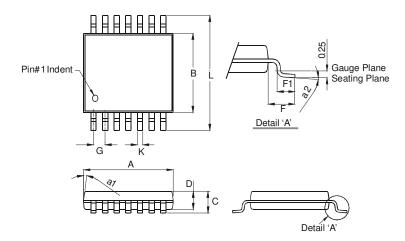
Package Outline Dimensions (All dimensions in mm.)

Package Type: SO-14



	SO-14						
Dim	Min	Max					
Α	1.47	1.73					
A 1	0.10	0.25					
A2	1.45	Тур					
В	0.33	0.51					
D	8.53	8.74					
Е	3.80	3.99					
е	1.27	Тур					
Н	5.80	6.20					
L	0.38	1.27					
θ	0°	8°					
All Dimensions in mm							

Package Type: TSSOP-14

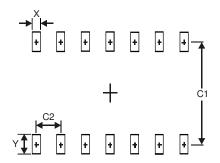


TSSOP-14		
Dim	Min	Max
a1	7° (4X)	
a2	0°	8°
Α	4.9	5.10
В	4.30	4.50
С	_	1.2
D	0.8	1.05
F	1.00 Typ	
F1	0.45	0.75
G	0.65 Typ	
K	0.19	0.30
Ĺ	6.40 Typ	
All Dimensions in mm		



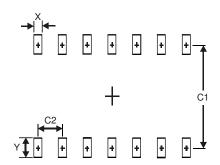
Suggested Pad Layout

Package Type: SO-14



Dimensions	Value (in mm)	
Х	0.60	
Υ	1.50	
C1	5.4	
C2	1.27	

Package Type: TSSOP-14



Dimensions	Value (in mm)
Х	0.45
Υ	1.45
C1	5.9
C2	0.65



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